



Product Change Notification

111550 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 111550 - 00
Change Title: Intel® Desktop Board DH61WW, GbE LAN, VGA, Boxed and Bulk
PCN 111550-00, Product Design
Add Cap to Improve CPU Power Quality
Date of Publication: June 08, 2012

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jun 25, 2012
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Description of Change to the Customer:

Add 1200PF/50V cap on location PC113 to improve CPU power quality.

Customer Impact of Change and Recommended Action:

This change has been evaluated to ensure there is no quality, reliability, or functional implication to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

For your information only: No change to Intel Ordering codes.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change AA	Post Change AA
LADH61WWB3	915046	G39552-300	G39552-301
BOXDH61WWB3	915113	G23116-300	G23116-301
BLKDH61WWB3	915114	G23116-300	G23116-301

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
June 08, 2012	00	Originally Published PCN